

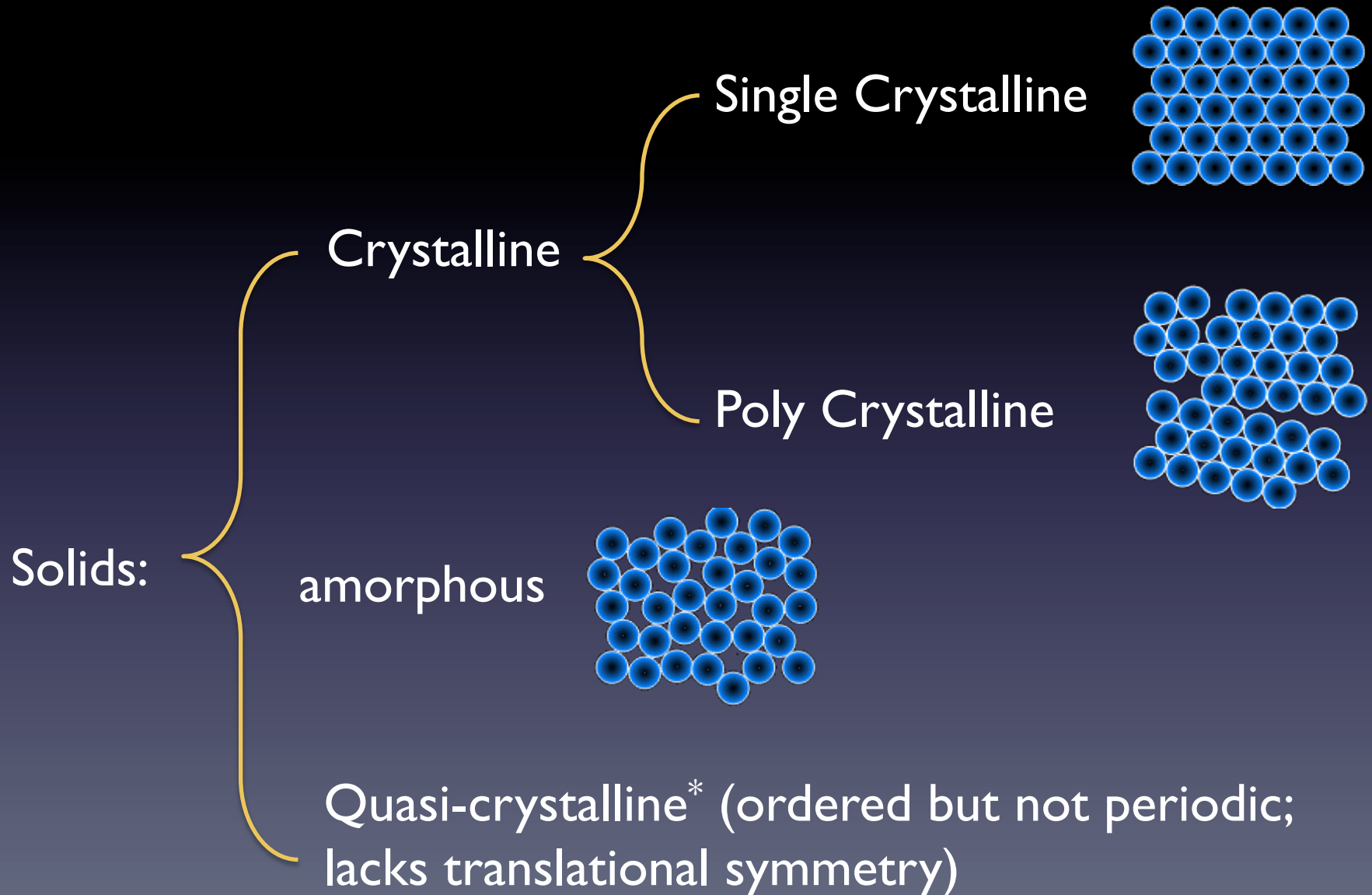
Plastic Deformation in Crystalline Materials

Lecture I: Overview

Kamyar Davoudi

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Structure of Solids



Crystalline vs Amorphous Solids

- Solids are often crystalline.
- A solid may be found in a crystalline or amorphous form. Each may have its own applications

For example:

- Crystalline silicon (Si) are used in ICs.
- Amorphous silicon (Si) are sometimes used in Li-ion batteries and solar cells
- Amorphous metals are often called **metallic glasses**
- It is really hard to make some metals amorphous (e.g. Ag)

Let's start with some

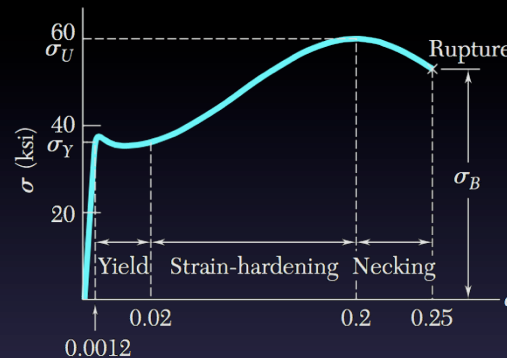
elementary diagrams

we saw in elementary mechanics of materials and ask

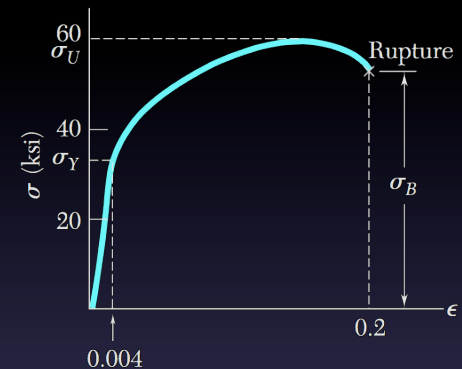
Some questions

Stress-Strain Curve

Stress-Strain Curve of a metal under uniaxial loading:
One of the first things we learned in mechanics of materials



Low carbon steel



Aluminum Alloy

[Beer & Johnston et al, mechanics of materials]

Questions:

- Why do materials become plastic? What is the mechanism of plastic deformation?
- Why stress-strain curves of different materials are different?
- How can we model strain hardening (= work hardening)?

Stress-Strain Curve – Loading and Unloading

Again what we saw in the first chapters of mechanics of materials

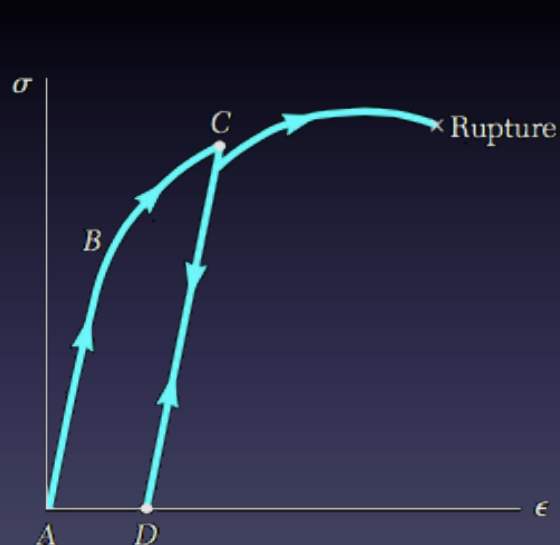


Fig. 2.14 Stress-strain characteristics of ductile material reloaded after prior yielding.

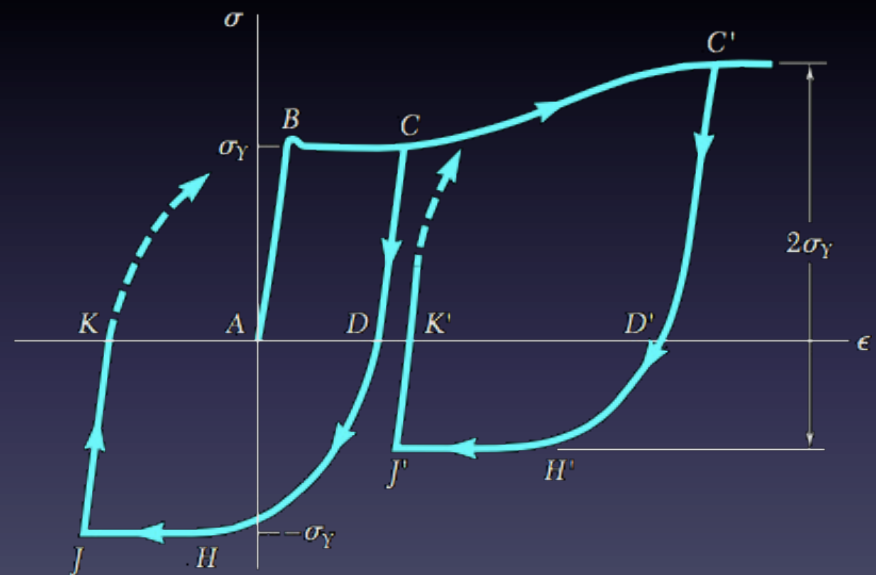
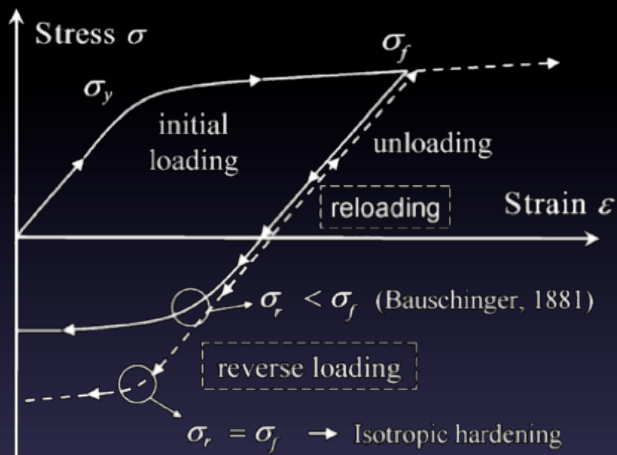
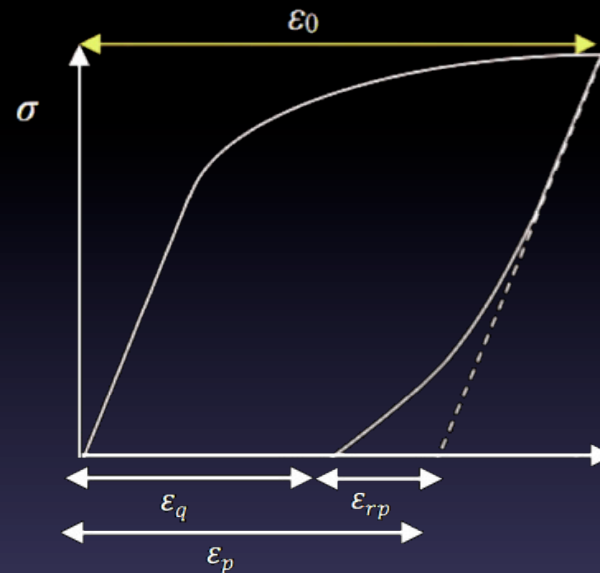


Fig. 2.15 Stress-strain characteristics for mild steel subjected to reverse loading.

Bauschinger Effect



[Xiang, Vlassak, Acta Mater, 2006]



ε_0 : total strain

ε_p : plastic strain or hypothetical residual strain

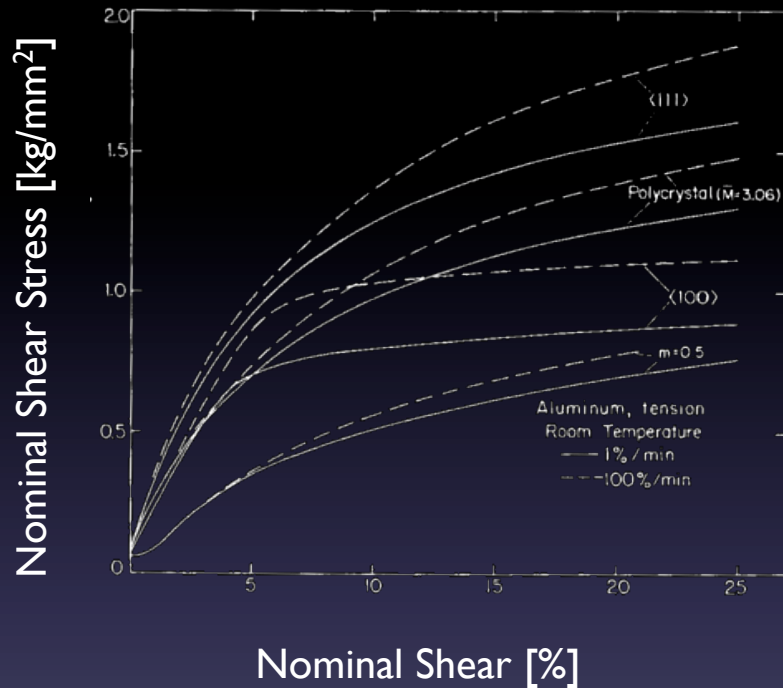
ε_q : residual strain

$\varepsilon_{rp} = \varepsilon_p - \varepsilon_q$: reverse plastic strain

Question:

What causes the Bauschinger effect?

Effects of Orientation & Loading Rates



Questions:

- How does the orientation affect the deformation?
- What is the difference between deformation of single crystal and polycrystal?
- How does the loading rate affect the deformation?

Nominal stress strain curves (without correction for area changes and orientation changes) for 99.99% pure Al, at two tensile strain rates: three single crystals of different orientations and one polycrystal of a grain size of 0.2 mm. After Kocks et al., Work Hardening, 1968

Effects of Temperature

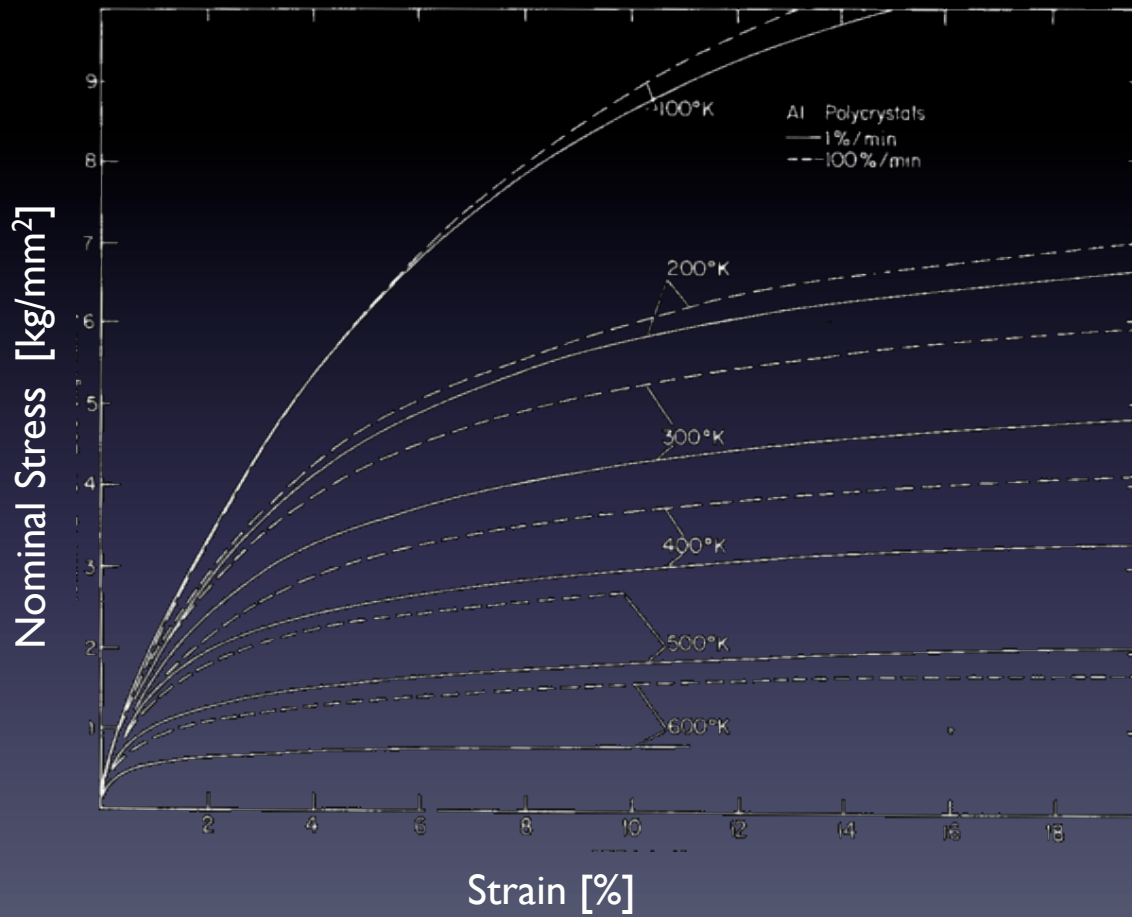
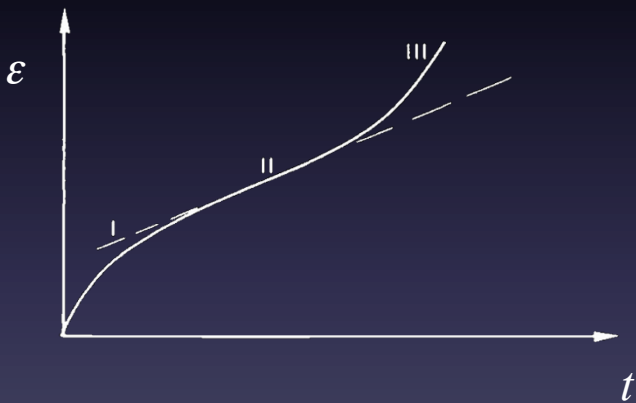
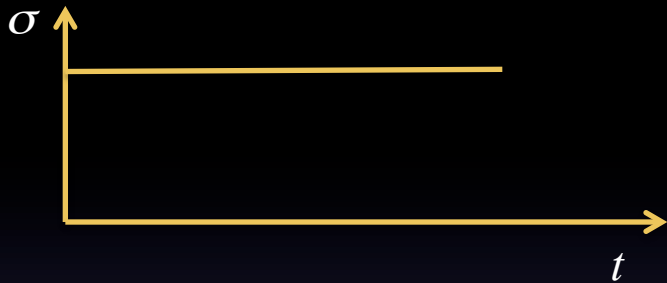


Fig. 19—Tensile stress-strain curves, at two tensile strain rates and at various temperatures, of 99.99 pct Al polycrystals of a grain size of 0.2 mm (15 pct of the grains being on the surface). After Kocks *et al.*⁷²

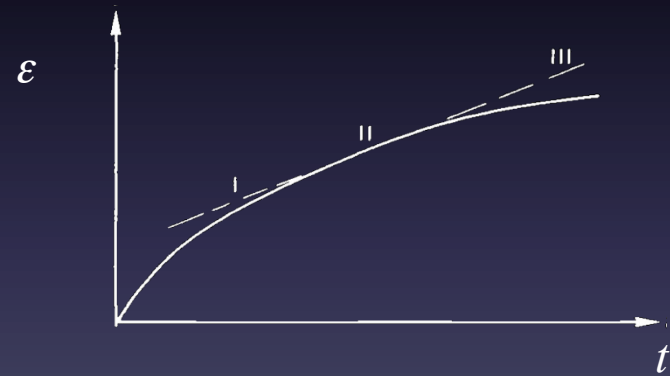
Question:

How does the temperature affect the hardening rate?

Creep



strain vs time (in tension)

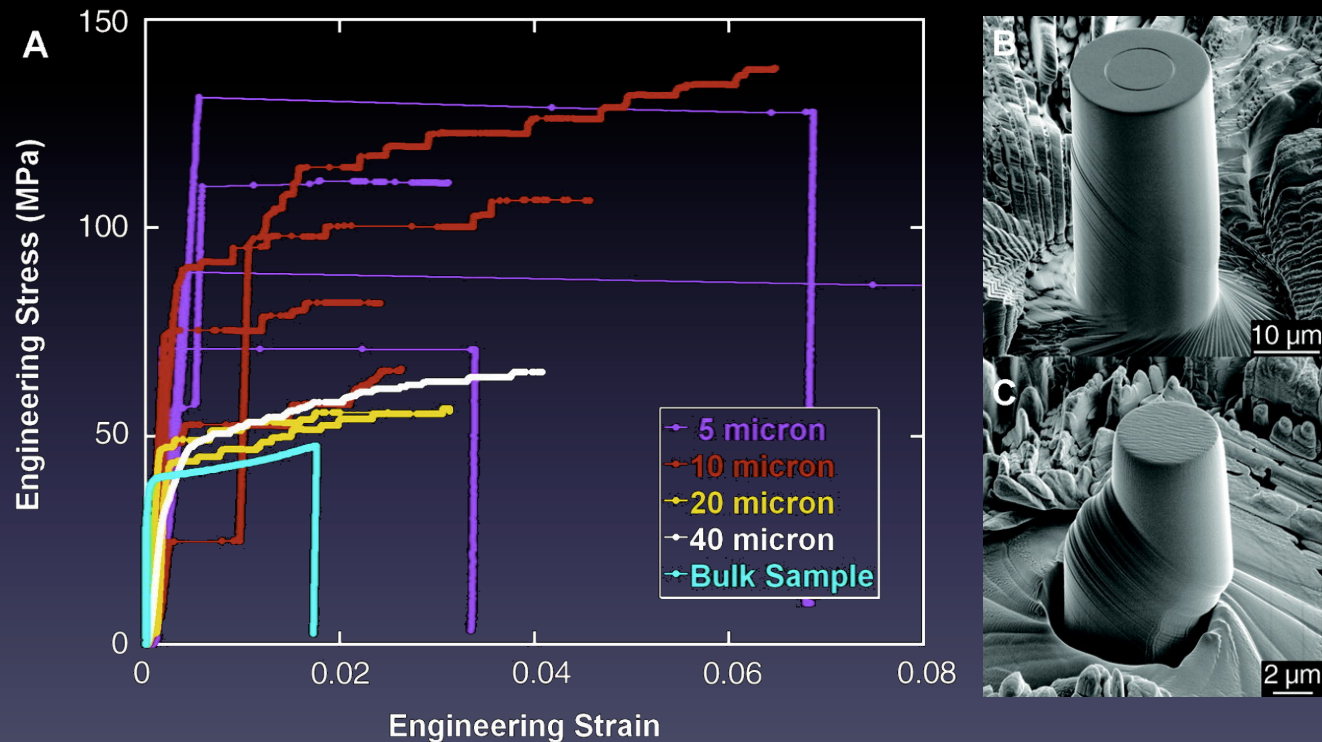


strain vs time (in compression)

Three stages: (I) primary creep regime (II) quasi-steady-state regime (III) tertiary creep regime

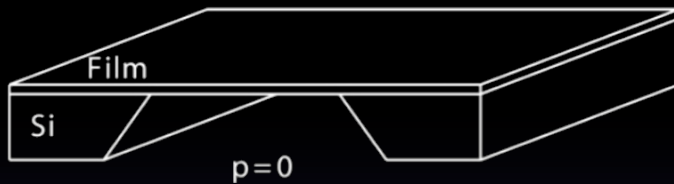
Question: What is the explanation for each regime?

Size Dependent Behavior: Experiment

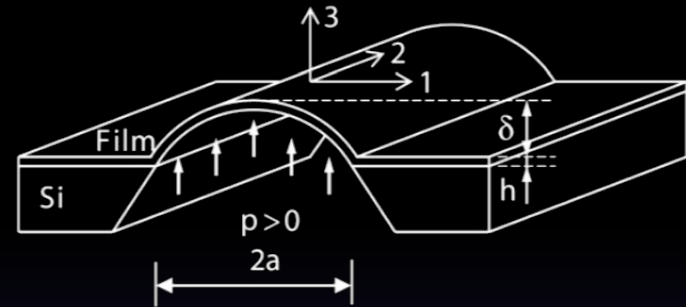


Pure Ni microsamples having a $\langle 134 \rangle$ orientation (A) stress-strain curves for samples with different diameters (B) SEM image at 4% strain (diameter 20 µm) (C) SEM image at 19% strain (diameter 5 µm) [Uchic et al., Science, 2008]

Another Experiment: Bulge Test



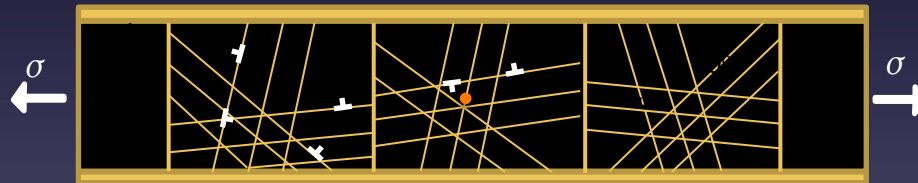
before pressure is applied



after pressure is applied

[Xiang, Vlassak, Scripta Mater., 2005]

Plane Strain Model:

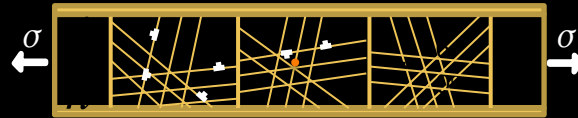
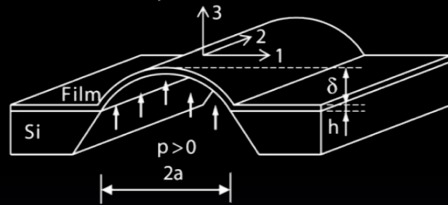


- Applied pressure p and membrane deflection h are measured
- Average stress and strain are determined using following (or more sophisticated) expressions

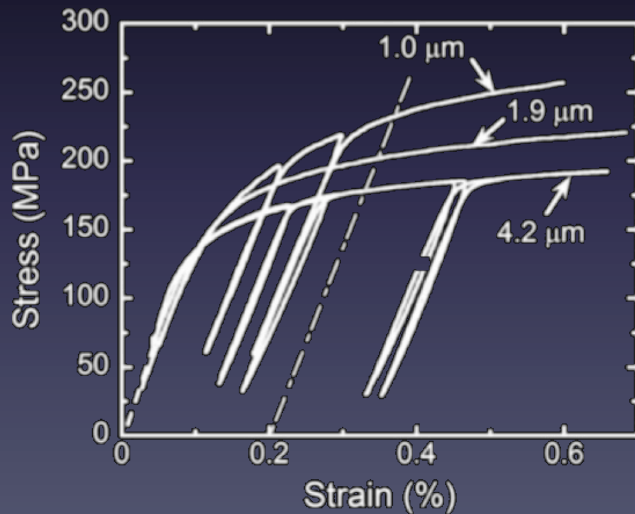
$$\sigma = \frac{pa^2}{2h\delta}, \quad \varepsilon = \varepsilon_0 + \frac{2\delta^2}{3a^2}$$

ε_0 : residual strain in the film

Bulge Test - II

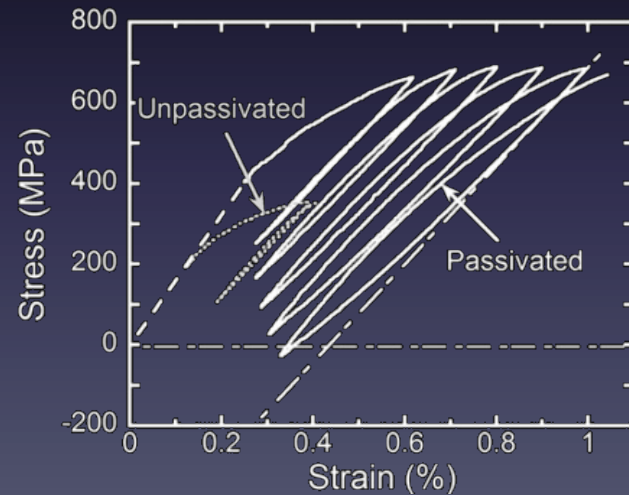


Effect of Film Thickness:



Cu Films with both surfaces passivated of different film thicknesses

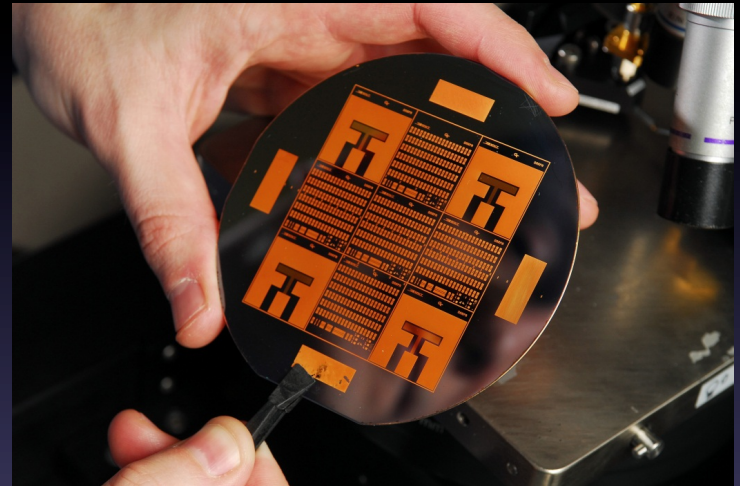
Effect of Passivation:



Cu film of thickness $h = 340$ nm

Importance of Study of Mechanical Behavior of Materials at Small Scales

Detailed and quantitative understanding of size effect is essential for a reliable design



<http://gtresearchnews.gatech.edu/newsrelease/mems-cad.htm>

Many of failure mechanisms are stress-driven

It is critical to know the strength of a component in a device and hence the level of stress it can support

Size Effect

1924

First Report by G.I. Taylor

1950s

Hall – Petch effect
Brenner's paper on whiskers
Conference in NY

1980s

Small Scale Devices

1990s

Experiments exhibited
size dependence

Continuum Mechanics Approach for Size Effect

In classical approach:

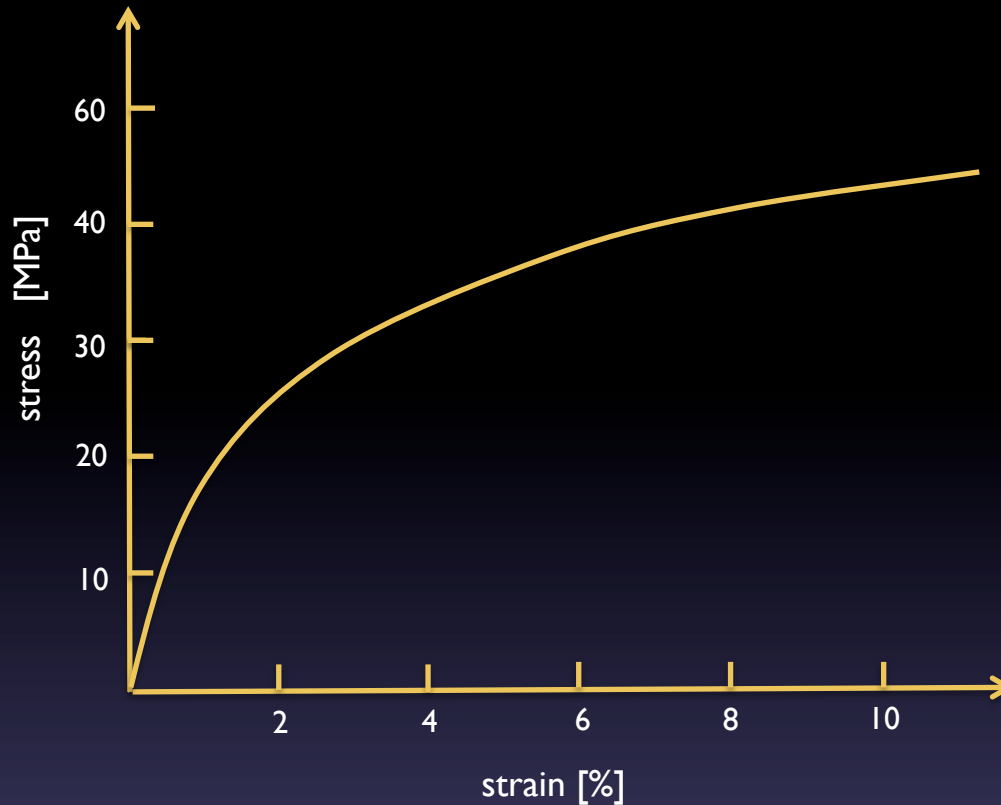
$$\dot{\sigma} = \text{function}(\dot{\epsilon}, T, \dots) \quad f(\sigma_{ij}, \epsilon_{ij}^p, k) = F(\sigma_{ij}, \epsilon_{ij}^p) - k^2(\epsilon_p^e) = 0$$

In nonlocal approach

$$\dot{\sigma} = \text{function}(\dot{\epsilon}, \nabla \dot{\epsilon}, \nabla^2 \dot{\epsilon}, \dots, T, \dots)$$

This requires introduction of one or more length parameters into the constitutive equation

There is no strain gradient theory that can be applied to all experiments



(Kocks, Trans ASME, 1970)

“it is sometimes said that the turbulent flow of fluids is the most difficult remaining problem in classical physics. Not so. Work hardening is worse.” (A.H. Cottrell, 2002)

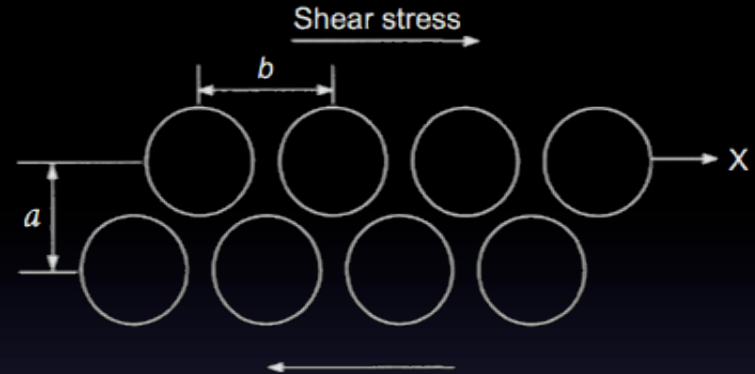
One Solution

- We should consider why and how crystals deform plastically.

Ideal Shear Strength

Consider a single crystal

$$\tau = \tau_{\max} \sin \frac{2\pi x}{b}$$



If $\tau < \tau_{\max}$: shear strain is elastic and will disappear when the stress is released.

For very low value of $\gamma = x / a$: $\tau = G \gamma$

Therefore:

$$\left(\frac{d\tau}{d\gamma} \right)_{x \rightarrow 0} = G$$

$$\tau_{\max} = \frac{Gb}{2\pi a} \approx \frac{G}{2\pi}$$

More accurate calculations showed that $\tau_{\max} = G/30$ which is still \gg measured shear strength

Why materials become plastic

Ideal shear strength \gg measured shear strength

81 years ago : Dislocations



G.I. Taylor

Egon Orowan

Michael Polyani

Work hardening was the first problem that was considered

16 volumes of “Dislocations in Solids”

1953

A.H. Cottrell: [Work hardening] was the first problem to be attempted by dislocation theory and may be the last to be solved

2003

U.F. Kocks & H. Mecking Work hardening is as hopeless as ever

2009

L. Kubin: There is presently no generally accepted theory explaining how and why organized dislocation microstructures emerge during plastic flow

Work hardening was the first problem that was considered



G.I. Taylor



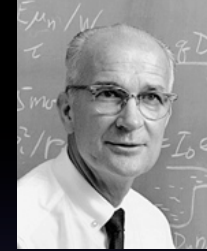
Egon Orowan



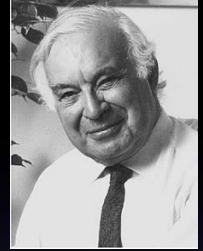
Nevil Mott*



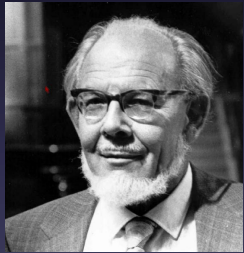
Rudolf Peierls*



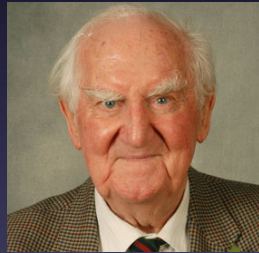
William Shockley*



F. Nabarro



Frederick C Frank



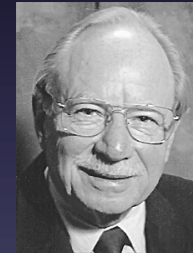
Alan Cottrell



J. Friedel



T Mura



U Fred Kocks

H. Mecking

John Hirth

Jens Lothe

J. & J. Weertman



Ladislav Kubin

* Nobel Laurites

Work Hardening Modeling

- Collective motion of dislocations → Plastic Deformation
- Individual processes are well understood
- Understanding overall effects is challenging without computer modeling

some main processes into the model

→ Discrete Dislocation Dynamics

